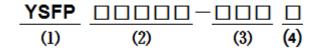
Features

- Assemblage design, sturdy structure.
- High inductance, high current, low magnetic loss, low ESR, small parasitic capacitance.
- Flat wire winding,achieve alow D.C.Resistance.
- Temperature rise current and saturation current is less influenced by environment.
- Operating temperature range:-55[°]C ~ +125[°]C.

Applications

- Low profile, high current power supplies.
- Battery powered devices.
- DC/DC converters in distributed power systems.
- DC/DC converters for field programmable gate array.

Product Identification



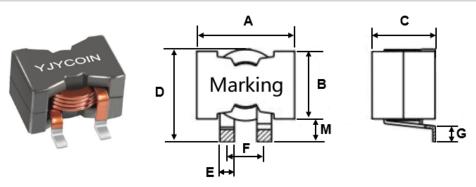
(1): Type

(2): Dimensions

(3): Inductance value

(4) : Inductance Tolerance: $M=\pm20\%$, $K=\pm10\%$, $J=\pm5\%$

■ Shapes and Dimensions (Unit: mm)



TYPE	A Max.	B Max.	C Max.	D Max.	Е	F	G
YSFP2920S	28.0	19.7	21.0	28.5	4.0±0.5	10.0±1.0	4.5±0.5



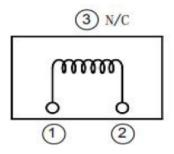
High Current Power Inductor

■ Electrical requirements

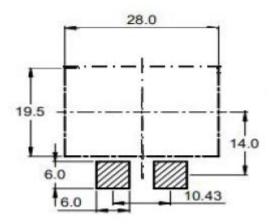
Part Number	L (uH)	Test Freq.	DCR Max.(mΩ)	I sat (A)	I rms (A)
YSFP2920S-100M	10±20%	100KHz/0.25V	2.5	32	33

- imes All test data is based on 25 $^{\circ}{\mathbb{C}}$ ambient.
- ℜ DC current(A) that will cause an approximate ΔT40 °C.
- DC current(A) that will cause L0 to drop approximately 30% Typ.
- ※ The part temperature (ambient + temp rise) should not exceed 125℃ under worst case operating conditions. Circuit design,component.PWB trace size and thickness,airflow and other cooling provision all affect the part temperature.Part temperature should be verified in the den application.

Electrical schematics



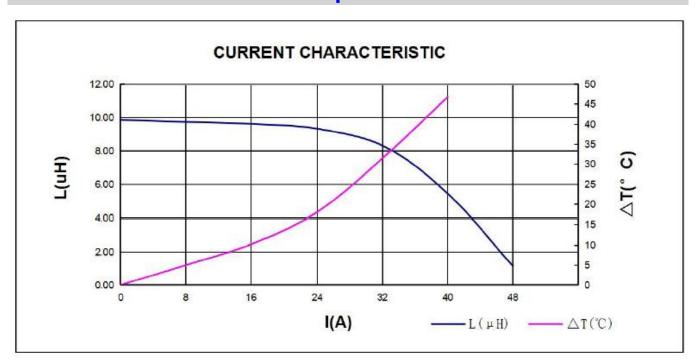
Recommended PCB Layout







■ Saturation current VS temperature rise current curve





High Current Power Inductor

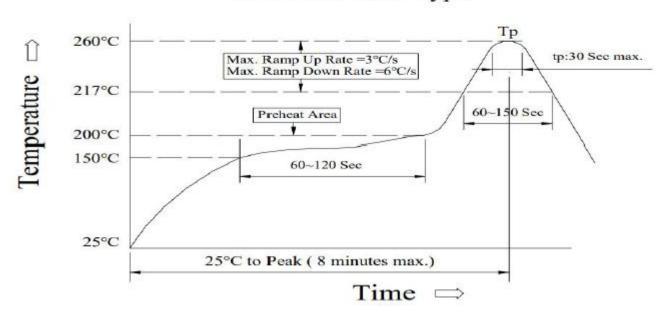
Reliability

Item	Specification and Requirement	Test Method	
	Tamaira la constitución OFO/ maio a aldan	Solder heat proof:	
Solder a bility test	Terminals area must have 95% min solder	①Preheating:160±10℃ for 90 seconds	
	coverage	②Retention time:245±5℃ for 2±0.5 seconds	
		① Vibration frequency:(10Hz to 55Hz to	
	Mru : . 50/ Mru	10Hz) in 60 seconds as a period	
Vibration test	Inductance change:Within±5% Without	② Vibration time: Reriod cycled for 2 hours	
	Mechanical damage such as break	in each of 3 mutual perpendicular directions.	
		③ Amplitude:1.5mm Max.	
		① Peak value:100G.	
	Inductance change: Within±5% Without	② Duration of pulse:11ms.	
Shock test	Mechanical damage such as break	③ Times in each positive and negative	
		direction of 3 mutual perpendicular directions	
		① Repeat 100 cycle as follow (-55±2℃	
		30±3 minutes),Room temperature,5 minutes	
	Inductance change: Within±5% Without	(+125±2℃,30±3 minutes)	
Thermal shock	Mechanical damage such as break	② Recovery:48+4/-0 hours of recovery	
		Under the standard condition after the test.	
		(see Note 1)	
I link town and we		① Environment condition:85±2℃	
High temperature	Inductance change: Within±5% Without	Applied current:Rated current	
life test	Mechanical damage such as break	② Duration:1000+4/-0 hours(see Note 1)	
		① Environment condition:60±2℃	
Humidity	Inductance change: Within±5% Without	Humidity:90-95%	
Resistance	Mechanical damage such as break	Applied current:Rated current	
		② Duration:1000+4/-0 hours(see Note 1)	
Low temperature	Inductance change: Within±5% Without	Store temperature -55±±2℃ for total	
life test	Mechanical damage such as break	1000+4/-0 hours	
High temperature	Inductance change: Within±5% Without	Store temperature +125±2°ℂfor total	
life test	Mechanical damage such as break	1000+4/-0 hours	



Reflow Profile

Power Choke Coil Type



■ Reflow Soldering Method

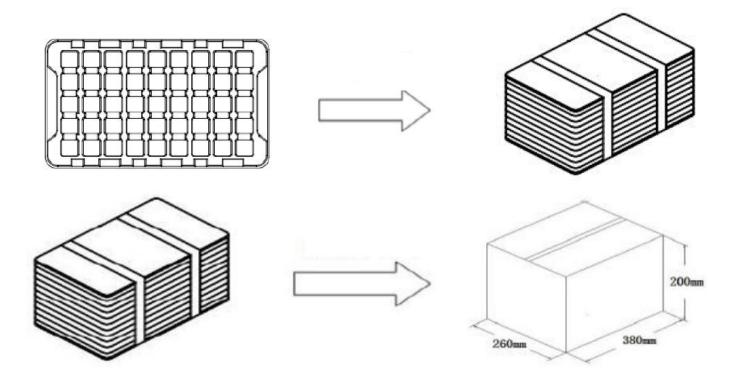
Reflow Soldering	Tp:255 ~ 260°C Max. 30 seconds(tp)		
Kellow Solderling	217℃ 60 ~ 150 seconds		
Pre-Heat	150 ~ 200°C 60 ~ 150 seconds		
Time 25℃ to peak temperature	8 minutes Max.		

Soldering iron method

350±5°C Max.3 seconds.



Packaging



Product Series	Quantity/Tray	Quantity/Carton
YSFP2920S	40 PCS	280 PCS